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Part Number: <u>0878030102</u>

Status: Active

Description: 1.00mm (.039") Pitch DDR-2 DIMM Socket, 25 Degree Angle, Through Hole, 1.8V

Voltage Key, 2.79mm (.110") Tail Length, 0.76 μ m (30 μ ") Gold (Au) Plating, 240

Circuits, Lead-free

Documents:

3D Model Product Specification PS-87803-003 (PDF)
Drawing (PDF) RoHS Certificate of Compliance (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Product Family Memory Module Sockets

Series <u>8780</u>

Comments No Lubricant at the Contact|Latches in OffWhite Color

Component Type Socket

JEDEC Outline MO-237

Product Name DDR2 DIMM

Physical

Circuits (Loaded) 240

Color - Resin Black, Natural Durability (mating cycles max) 25
Entry Angle 25° Angle Flammability 94V-0
Keying to Mating Part Yes

Material - Plating Mating Gold Material - Plating Termination Tin

Material - Resin High Temperature Thermoplastic

PC Tail Length (in) 0.110 In PC Tail Length (mm) 2.79 mm PCB Locator Yes **PCB** Retention Yes PCB Thickness Recommended (in) 0.062 In PCB Thickness Recommended (mm) 1.60 mm Packaging Type Tray Pitch - Mating Interface (in) 0.039 In Pitch - Mating Interface (mm) 1.00 mm Plating min: Mating (µin) 30 Plating min: Mating (µm) 0.76 Plating min: Termination (µin) 100

Plating min: Termination (µm)

2.54

Temperature Range - Operating

-55°C to +85°C

Termination Interface: Style

Through Hole

Electrical

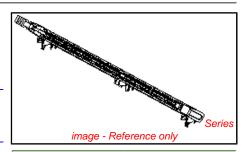
Current - Maximum per Contact 0.5A

Voltage - Maximum 30V AC (RMS)/DC Voltage Key 1.8V, Center

Solder Process Data

Duration at Max. Process Temperature (seconds) 5

Lead-free Process Capability SMC & Wave Capable (TH only)



China RoHS

EU RoHS
ELV and RoHS
Compliant
REACH SVHC

Contains SVHC: No Halogen-Free Status Not Halogen-Free

Need more information on product environmental compliance?

Email <u>productcompliance@molex.com</u>
For a multiple part number RoHS Certificate of Compliance, click here

Please visit the <u>Contact Us</u> section for any non-product compliance questions.

Search Parts in this Series

87803 Series

Mates With

JEDEC standard 1.27mm modules

Max. Cycles at Max. Process Temperature2Process Temperature max. C260

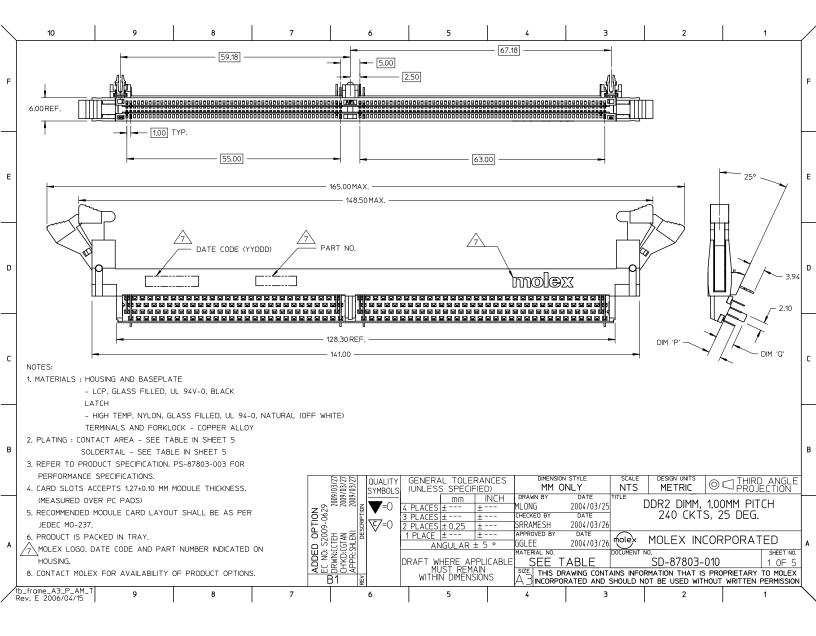
Material Info

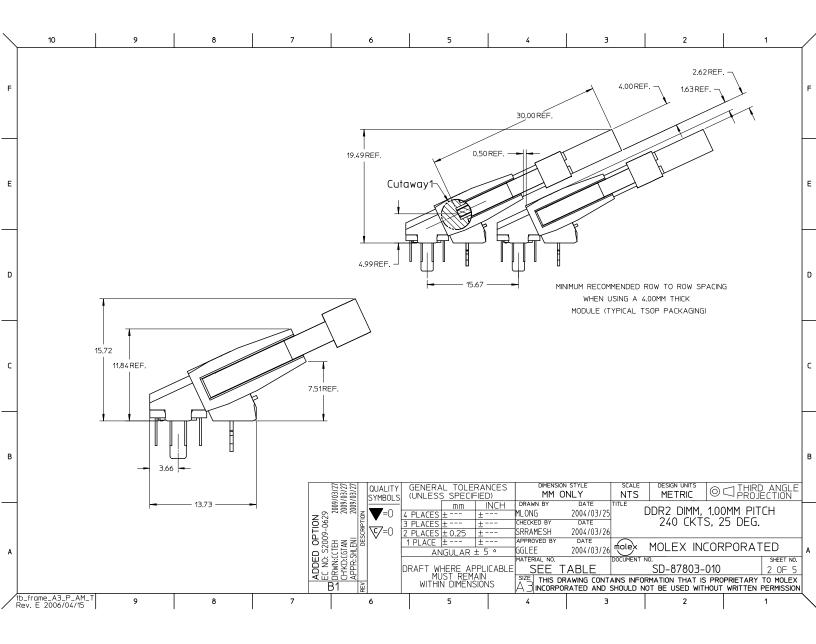
Reference - Drawing Numbers

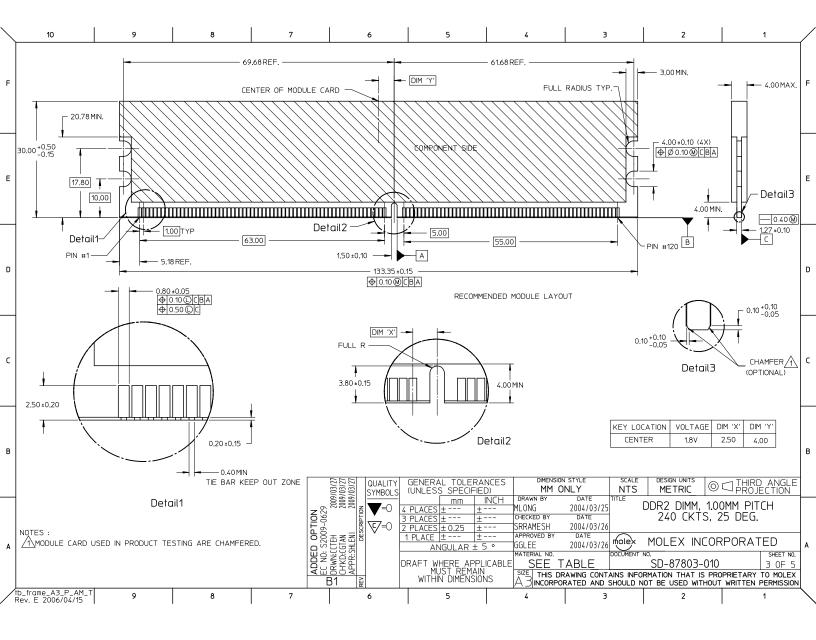
Product Specification PS-87803-003
Sales Drawing SD-87803-010

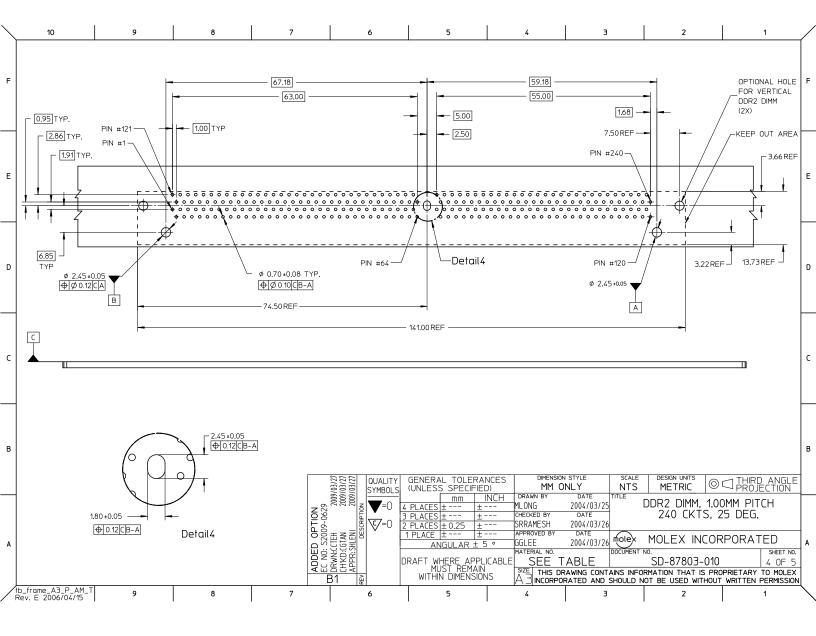
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F	,			,				,				F
E		PART NO.	VOLTAGE KEY	DIM 'P'	DIM 'Q'	RECOMMENDED PCB THICKNESS	CONTACT AREA PLATING	SOLDERTAIL PLATING	LUBF	RICATION		E
D		87803-0002 87803-0022 87803-0012 87803-0032 87803-0052 87803-0062	1.8V	2.79 3.18 4.00	3.18	1.57 2.36 3.18	0.38uM/ 15u" GOLD OVER 1.27uM/ 50u" MIN NICKEL	_2.54uM/ 100u" MIN. TIN (MATTE) OVER 1.27uM/ 50u" MIN NICKEL	,	NO YES NO YES NO YES		D
C		87803-0102 87803-0122 87803-0112 87803-0132 87803-0152		2.79 3.18	3.18	1.57 2.36 3.18	0.76uM/ 30u" GOLD OVER 1.27uM/ 50u" MIN NICKEL		KEL	NO YES NO YES NO		С
В		87803-0162								ÆS		В
					D OPTION	CHKD:CGTAN 2009/03/27 CHKD:CGTAN 2009/03/27 APPR:SHLENI 2009/03/27 OESCRIPTION OF CHKD:CGTAN 2009/03/27 OF CHKD:CGTAN 20	GENERAL TOLERANCE (UNLESS SPECIFIED) Mm INC 4 PLACES ± ± 3 PLACES ± ± 2 PLACES ± 0.25 ± 1 PLACE ± ± ANGULAR ± 5 °	MM ONLY	/26 /26 molex	240 CK MOLEX II	○ □ PRÖJEĆ 1, 1.00MM PITCH TS, 25 DEG. NCORPORATE	H A
	b_frame_A3_P_AM_T lev. E 2006/04/15	9	8		7	BT APPRISE	DRAFT WHERE APPLICA MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO.	DOCUMENT N	SD-87803	3-010 5	SHEET NO. 5 OF 5 MOLEX RMISSION